# **Notice for TAIYO YUDEN products**

Please read this notice before using the TAIYO YUDEN products.

## REMINDERS

Product information in this catalog is as of October 2010. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or usage of the Products.

Please note that Taiyo Yuden Co., Ltd. shall not be responsible for any defects in products or equipment incorporating such products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment.(for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation,( automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance. Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

- The contents of this catalog are applicable to the products which are purchased from our sales offices or distributors (so called "TAIYO YUDEN's official sales channel").

  It is only applicable to the products purchased from any of TAIYO YUDEN's official sales channel.
- Please note that Taiyo Yuden Co., Ltd. shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from your usage of products in this catalog. Taiyo Yuden Co., Ltd. grants no license for such rights.
- Caution for export

Certain items in this catalog may require specific procedures for export according to "Foreign Exchange and Foreign Trade Control Law" of Japan, "U.S. Export Administration Regulations", and other applicable regulations. Should you have any question or inquiry on this matter, please contact our sales staff.

# SMD INDUCTORS LARGE CURRENT TYPE





### **FEATURES**

- SMD inductor.
- It corresponds to High current.
- Simple and original magnetic shield structure.

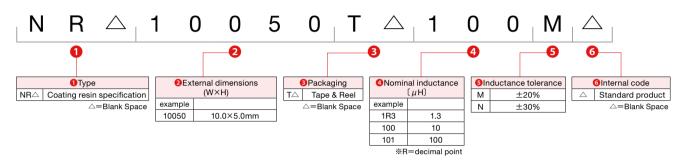
### APPLICATIONS

Power supply circuits / DC-DC converters in a variety of applications such as PDP TV, LCD TV, HDD, PC, etc.

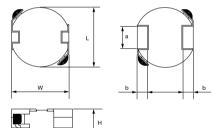
### OPERATING TEMPERATURE RANGE

 $-25^{\circ}\text{C} \sim 105^{\circ}\text{C}$  (Including self-generated heat)

### ORDERING CODE

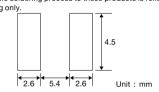


### EXTERNAL DIMENSIONS/STANDARD QUANTITY



#### Recommended Land Patterns

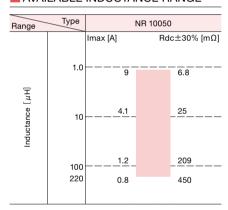
- Surface Mounting
- · Mounting and soldering conditions should be checked
- · Applicable soldering process to these products is reflow soldering only.



Туре	L	W	Н	а	b	Standard Quantity [pcs] Tape & Reel
NR 10050	10.0±0.3 (0.394±0.012)	9.8±0.5 (0.386±0.020)	5.0 max (0.197 max)	4.0 (0.16)	1.75 (0.07)	500
						Linit i mana (inah)

#### Unit: mm (inch)

### AVAILABLE INDUCTANCE RANGE



### PART NUMBERS

### NR 10050 type

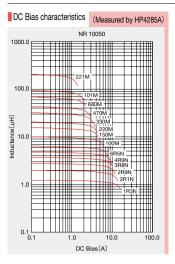
	EHS (Environn	nental	Indicators	Self-resonant	DC Resistance	Rated curre	ent ※) [mA]	Measuring
Ordering code	Hazardo Substan	1 1//HI	Inductance Tolerance	frequency [Ω] (±30%)	Saturation current Idc1	Temperature rise current Idc2	frequency [kHz]	
NR10050T1R3N	RoHS	1.3		53	0.0068	11000	9000	
NR10050T2R1N	RoHS	2.1		37	0.008	10000	8300	
NR10050T2R9N	RoHS	2.9	1 +200/	29	0.0093	8200	7300	
NR10050T3R8N	RoHS	3.8	)	26	0.013	7300	6800	
NR10050T4R9N	RoHS	4.9		23	0.015	6600	6000	
NR10050T6R5N	RoHS	6.5		19	0.018	6000	5200	
NR10050T100M	RoHS	10		15	0.025	4700	4100	100
NR10050T150M	RoHS	15		11	0.035	3600	3200	100
NR10050T220M	RoHS	22		10	0.045	2600	2500	
NR10050T330M	RoHS	33	±20%	8.2	0.066	2500	2100	
NR10050T470M	RoHS	47	T ±20%	7.0	0.092	2000	1800	
NR10050T680M	RoHS	68	7	5.6	0.144	1700	1500	
NR10050T101M	RoHS	100		4.6	0.209	1300	1200	
NR10050T221M	RoHS	220		3.0	0.450	1000	800	

<sup>\*)</sup> The saturation current value (Idc1) is the DC current value having inductance decrease down to 30%. (at 20°C)

<sup>\*\*)</sup>The temperature rise current value (ldc2) is the DC current value having temperature increase up to 40°C. (at 20°C) \*\*)The maximum rated current is the DC current value that satisfies both of current value Saturation current value and temperature rise current value. (at 20°C)

<sup>\*</sup> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs.

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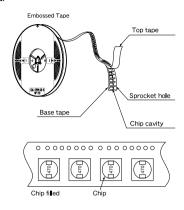


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#### **1**Minimum Quantity

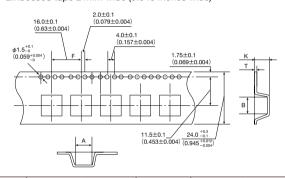
Tuno	Standard Quantity [pcs]
Type	Tape & Reel
NR 10050	500

### **2**Tape Material



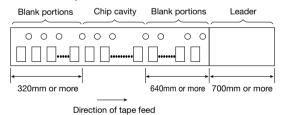
### ③Taping dimensions

### Embossed tape 24mm wide (0.945 inches wide)

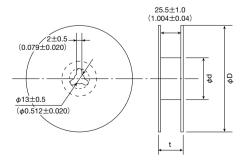


Type	Chip	cavity	Insertion pitch	Tape th	ckness	
туре	Α	В	F	Т	K	
NR 10050	10.4±0.1 (0.409±0.004)	9.9±0.1 (0.390±0.004)	16.0±0.1 (0.630±0.004)	0.5±0.05 (0.020±0.002)	5.7±0.1 (0.224±0.004)	
				Į.	Jnit: mm (inch)	

## 4 Leader and Blank portion



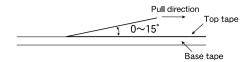
### ⑤Reel size



Tupo	Reel size (Reference values)			
Туре	φD	φd	t (max.)	
NR 10050	330±3 (12.99±0.118)	80±2 (3.15±0.078)	30.5 (1.201)	
			Unit: mm (inch)	

### **6**Top Tape Strength

The top tape requires a peel-off force of 0.1 to 1.3N in the direction of the arrow as illustrated below.



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#### Wound Chip power inductor (NR, NS-series)

1. Operating Temperature Range	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	-25~+120°C
NR10050 Type	−25~+105°C
NS12555, NS12565, NS12575Type	-40~+125°C
Test Method and Remarks Including self-generated heat	

2. Storage Temperature Range	
NR30/40/50/60/80, NRV30, NRH24/30,	
NRS40/50/60/80 Type	40 1050
NR10050 Type	-40~+85°C
NS12555 NS12565 NS12575Type	

[Test Method and Remarks]

NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type: —5 to 40°C for the product with taping.

3. Rated current	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	
NR10050 Type	Within the specified tolerance
NS12555, NS12565, NS12575Type	

4. Inductance	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	
NR10050 Type	Within the specified tolerance
NS12555, NS12565, NS12575Type	

[Test Method and Remarks]

LCR Meter: HP 4285A or equivalent, Measuring frequency: Specified frequency
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NS12555, NS12565, NS12575Type: LCR Meter : HP 4285A or equivalent, 100KHz, 1V NR10050 Type : LCR Meter : HP 4263A or equivalent, 100KHz, 1V

5. DC Resistance	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	M
NR10050 Type	Within the specified tolerance
NS12555, NS12565, NS12575Type	
[Test Method and Remarks]	

DC ohmmeter: HIOKI 3227 or equivalent

	6. Self resonance frequency	
	NR30/40/50/60/80, NRV30, NRH24/30,	
NRS40/50/60/80 Type		
NR10050 Type		Within the specificatio
	NOTOREE NOTOREE NOTORIETURO	]

[Test Method and Remarks]

NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type:

Inpedance analyzer/material analyzer : HP4291A or equivalent HP4191A, 4192A or equivalent

7. Temperature characteristic		
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Inductance change: Within ±20%	
NR10050 Type	madetanee change : Wallin = 20/0	
NS12555, NS12565, NS12575Type	Inductance change: Within ±15%	

[Test Method and Remarks]

NS12555, NS12565, NS12575Type:

NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type: Measurement of inductance shall be taken at temperature range within -25°C~+85°C.

Change of maximum inductance deviation in step 1 to 5

Temperature at step 1	20℃
Temperature at step 2	Minimum operating temperature
Temperature at step 3	20°C (Standard temperature)
Temperature at step 4	Maximum oparating temperature
Temperature at step 5	20℃

With reference to inductance value at  $\pm 20^{\circ}$ C., change rate shall be calculated. Measurement of inductance shall be taken at temperature range within  $\pm 40^{\circ}$ C.

With reference to inductance value at +20°C., change rate shall be calculated.

8. Resistance to flexure of substrate	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	No damage
NR10050 Type	
NS12555 NS12565 NS12575Type	No damage

[Test Method and Remarks]

NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NS12555, NS12565, NS12575Type

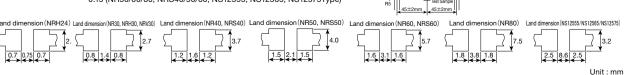
The test samples shall be soldered to the test board by the reflow. As illustrated below, apply force in the direction of the arrow indicating until deflection of the test board

reaches to 2 mm. Test board size Test board material

100×40×1.0

glass epoxy-resin 0.10 (NR30/40, NRS40, NRH24/30, NRV30) Solder cream thickness :

0.15 (NR50/60/80, NRS40/50/60, NS12555, NS12565, NS12575Type)



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### RELIABILITY DATA

Wound Chip power ind	uctor(NR, N	S-series)
9. Insulation resistance:	between wire	5
NR30/40/50/60/80, NRV30	0, NRH24/30,	
NRS40/50/60/80 Type		
NR10050 Type NS12555, NS12565, NS125	75Tvne	
NO12000, NO1200	тэтуре	
40 1 1 1 1 1 1		
10. Insulation resistance NR30/40/50/60/80, NRV30		a and core
NRS40/50/60/80 Type	U, INFIEZ4/3U,	
NR10050 Type		
NS12555, NS12565, NS125	75Туре	
11. Withstanding voltage	· between wir	e and core
NR30/40/50/60/80, NRV30		
NRS40/50/60/80 Type		
NR10050 Type		
NS12555, NS12565, NS125	75Type	
12. Adhesion of terminal		
NR30/40/50/60/80, NRV30	0, NRH24/30,	
NRS40/50/60/80 Type NR10050 Type		Shall not come off PC board
NS12555, NS12565, NS125	75Type	
Test Method and Remark		
		NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :
The test samples shall •Applied force		o the test board by the reflow. and Y directions.
·Duration	: 5s.	■ 10N, 5s
<ul> <li>Solder cream thickne</li> </ul>	ss: 0.15mm.	Li Liun, ss
NR10050 Type :		
·Applied force: 5N to	X and Y direc	tions.
•Duration : 5s.		
13. Resistance to vibration		
NR30/40/50/60/80, NRV30 NRS40/50/60/80 Type	0, NRH24/30,	
NR10050 Type		Inductance change: Within ±10%  No significant abnormality in appearance.
111110000 1390		To significant abnormanty in appearance.
NS12555, NS12565, NS125	75Type	
NS12555, NS12565, NS125 Test Method and Remark		
Test Method and Remark NR30/40/50/60/80, NRV30	ks] 0, NRH24/30, I	 NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type :
Test Method and Remark NR30/40/50/60/80, NRV30 The test samples shall	ks] 0, NRH24/30, I be soldered t	o the test board by the reflow.
Test Method and Remark NR30/40/50/60/80, NRV30 The test samples shall Then it shall be submit	ks] 0, NRH24/30, I be soldered t tted to below t	o the test board by the reflow.
Test Method and Remark NR30/40/50/60/80, NRV30 The test samples shall Then it shall be submit Frequency Range	ks] 0, NRH24/30, I l be soldered t tted to below t 10~55Hz	o the test board by the reflow. est conditions.
Test Method and Remark NR30/40/50/60/80, NRV30 The test samples shall Then it shall be submit	(s] 0, NRH24/30, I be soldered to ted to below to 10~55Hz 1.5mm (Ma	o the test board by the reflow.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude	(s] 0, NRH24/30, I be soldered to ted to below to 10~55Hz 1.5mm (Ma	o the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²)
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude	(s) 0, NRH24/30, I be soldered to ted to below t 10~55Hz 1.5mm (Ma 10Hz to 55I X Y Fc	o the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²)
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method	ts] 0, NRH24/30, I be soldered to ted to below to 10~55Hz 1.5mm (Ma) 10Hz to 55H	o the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method	cs] 0, NRH24/30, I be soldered to the do below	o the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method	cs] 0, NRH24/30, I be soldered to the do below	or the test board by the reflow.  est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method Time	cs] 0, NRH24/30, 1 be soldered the ted to below to 10~55Hz 1.5mm (Ma 10Hz to 55i X Y Fo Z  ars of recovery	or the test board by the reflow.  est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method Time Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV36	cs] 0, NRH24/30, 1 be soldered the ted to below to 10~55Hz 1.5mm (Ma 10Hz to 55i X Y Fo Z  ars of recovery	or the test board by the reflow.  est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit  Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV3(NRS40/50/60/80 Type	cs] 0, NRH24/30, 1 be soldered the ted to below to 10~55Hz 1.5mm (Ma 10Hz to 55i X Y Fo Z  ars of recovery	or the test board by the reflow.  est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.
Test Method and Remark NR30/40/50/60/80, NRV31 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV30, NRS40/50/60/80 Type NR10050 Type	cs] 0, NRH24/30, be soldered to teed to below to 10~55Hz 1.5mm (Ma 10Hz to 55Hz Y Fo Z ors of recovery	or the test board by the reflow.  est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method Time Recovery: At least 2h NR30/40/50/60/80, NRV30 NRS40/50/60/80 Type NR10050 Type NS12555, NS12565, NS125	ss] 0, NRH24/30, be soldered to teed to below to 10~55Hz 1.5mm (Ma 10Hz to 55Hz Z rs of recovery	or the test board by the reflow.  est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.
Test Method and Remark NR30/40/50/60/80, NRV31 The test samples shall Then it shall be submit  Frequency Range Total Amplitude Sweeping Method Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV31 NRS40/50/60/80 Type NR10550 Type NS12555, NS12565, NS125  [Test Method and Remark	ss] 0, NRH24/30, be soldered the ted to below the decision of	or the test board by the reflow.  est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.
Test Method and Remark NR30/40/50/60/80, NRV31 The test samples shall Then it shall be submit  Frequency Range Total Amplitude Sweeping Method Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV31 NRS40/50/60/80 Type NR10550 Type NS12555, NS12565, NS125  [Test Method and Remark	cs] 0, NRH24/30, 1 be soldered to be soldered to tee do below	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  Tunder the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit  Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV30 NRS40/50/60/80 Type NR10050 Type NS12555, NS12565, NS125  Test Method and Remark The test samples shall Flux: Methanol soluti	ss] 0, NRH24/30, be soldered to teed to below to 10~55Hz 1.5mm (Ma 10Hz to 55Hz Z rs of recovery 0, NRH24/30, 75Type (ss] be dipped in to containing	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit  Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV30 NRS40/50/60/80 Type NR10050 Type NS12555, NS12565, NS125  [Test Method and Remark The test samples shall Flux: Methanol soluti NR30/40/50/60/80, NRV30	ss] 0, NRH24/30, be soldered to teed to below to 10~55Hz 1.5mm (Ma 10Hz to 55Hz Z	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  Tunder the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit  Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV31 NRS40/50/60/80 Type NR10050 Type NS12555, NS12565, NS125  [Test Method and Remark The test samples shall Flux: Methanol solutions NR30/40/50/60/80, NRV31  Solder Temperature	ss] 0, NRH24/30, be soldered to teed to below to 10~55Hz 1.5mm (Ma 10Hz to 55Hz Z rs of recovery 0, NRH24/30, 75Type (ss] be dipped in to containing	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit  Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV30 NRS40/50/60/80 Type NR10050 Type NS12555, NS12565, NS125  Test Method and Remark The test samples shall Flux: Methanol soluti NR30/40/50/60/80, NRV30  Solder Temperature Time	ss] 0, NRH24/30, be soldered to teed to below to 10~55Hz 1.5mm (Ma 10Hz to 55Hz Z	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type:
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit  Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV30 NRS40/50/60/80 Type NR10050 Type NS12555, NS12565, NS125  Test Method and Remark The test samples shall Flux: Methanol soluti NR30/40/50/60/80, NRV30  Solder Temperature Time	ss] 0, NRH24/30, be soldered to teed to below to 10~55Hz 1.5mm (Ma 10Hz to 55Hz Z	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV30 NRS40/50/60/80 Type NR10050 Type NS12555, NS12565, NS125 [Test Method and Remark The test samples shall Flux: Methanol solution NR30/40/50/60/80, NRV30  Solder Temperature Time  **Immersion depth: All signature in the	ss] 0, NRH24/30, be soldered to teed to below to teed to below to 10~55Hz 1.5mm (Ma 10Hz to 55Hz 2	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type:
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method Time Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV30, NRS40/50/60/80 Type NR10555, NS12565, NS1255 Test Method and Remark The test samples shall Flux: Methanol solution NR30/40/50/60/80, NRV30 Solder Temperature Time  **Immersion depth: All signature and the signature of	ss] 0, NRH24/30, 1 be soldered to be below to ted to ted to below to ted to	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type:
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV31 NRS40/50/60/80 Type NR10050 Type NR10050 Type NR10050 Type NS12555, NS12565, NS125  [Test Method and Remark The test samples shall Flux: Methanol soluti NR30/40/50/60/80, NRV31  Solder Temperature Time  **Immersion depth: All sin NR30/40/50/60/80, NRV31  15. Resistance to solderin NR30/40/50/60/80, NRV30	ss] 0, NRH24/30, 1 be soldered to be below to ted to ted to below to ted to	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :  Ing terminal shall be immersed.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method Time Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV30, NRS40/50/60/80 Type NR10555, NS12565, NS1255 Test Method and Remark The test samples shall Flux: Methanol solution NR30/40/50/60/80, NRV30 Solder Temperature Time  **Immersion depth: All signature and the signature of	ss] 0, NRH24/30, 1 be soldered to be below to ted to ted to below to ted to	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type:
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV30, NRV30, NRS40/50/60/80 Type NR10050 Type NR10050 Type NR12555, NS12565, NS125  Itest Method and Remark The test samples shall Flux: Methanol soluti NR30/40/50/60/80, NRV30, Solder Temperature Time  **Immersion depth: All sides in the sides of the	ss] 0, NRH24/30, be soldered to teed to below to 10~55Hz 1.5mm (Ma 10Hz to 55Hz 2	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s³) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :  Inductance change : Within ±10%
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method Time Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV30, NRS40/50/60/80 Type NR10050 Type NR10050 Type NR10555, NS12565, NS12565 Test Method and Remark The test samples shall Flux: Methanol soluti NR30/40/50/60/80, NRV30, NRV30, Solder Temperature Time **Immersion depth: All si  15. Resistance to solderii NR30/40/50/60/80, NRV30, NRV30, NRV30/50/60/80 Type NR10050 Type NR10050 Type NR10555, NS12565, NS1256 Test Method and Remark	ss] 0, NRH24/30, 1 be soldered to tend to below to tend to below to tend to te	of the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type:  Inductance change: Within ±10% No significant abnormality in appearance.
Test Method and Remark NR30/40/50/60/80, NRV31 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV31 NRS40/50/60/80 Type NR10050 Type NR10050 Type NS12555, NS12565, NS125 Itest Method and Remark The test samples shall Flux: Methanol solution NR30/40/50/60/80, NRV31 Solder Temperature Time  **Immersion depth: All sin NR30/40/50/60/80, NRV31 NR30/40/50/60/80 Type NR10050 Type NS12555, NS12565, NS125 Itest Method and Remark NR30/40/50/60/80, NRV31 Item Method and Remark NR30/40/50/60/80, NRV31 Item Method and Remark NR30/40/50/60/80, NRV31 Item Method and Remark NR30/40/50/60/80, NRV31	ss] 0, NRH24/30, 1 be soldered to be soldered to teed to below to teed to below to teed to be soldered to teed to below to teed to be soldered to teed to below to teed to be soldered to teed to below to teed to soldered to teed to soldered to sol	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s³)  Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  Funder the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type:  Inductance change: Within ±10%  No significant abnormality in appearance.
Test Method and Remark NR30/40/50/60/80, NRV31 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV31 NRS40/50/60/80 Type NR10050 Type NR10050 Type NS12555, NS12565, NS125 Itest Method and Remark The test samples shall Flux: Methanol solution NR30/40/50/60/80, NRV31 Solder Temperature Time  **Immersion depth: All sin NR30/40/50/60/80, NRV31 NR30/40/50/60/80 Type NR10050 Type NS12555, NS12565, NS125 Itest Method and Remark NR30/40/50/60/80, NRV31 Item Method and Remark NR30/40/50/60/80, NRV31 Item Method and Remark NR30/40/50/60/80, NRV31 Item Method and Remark NR30/40/50/60/80, NRV31	ss] 0, NRH24/30, 1 be soldered to be soldered to teed to below to teed to below to teed to be soldered to teed to below to teed to be soldered to teed to below to teed to be soldered to teed to below to teed to soldered to teed to soldered to sol	of the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type:  Inductance change: Within ±10% No significant abnormality in appearance.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV31 NRS40/50/60/80 Type NR10050 Type NR10050 Type NS12555, NS12565, NS125  Test Method and Remark The test samples shall Flux: Methanol soluti NR30/40/50/60/80, NRV31  Solder Temperature Time  **Immersion depth: All sides the sample shall	ss] 0, NRH24/30, 1 be soldered to be soldered to teed to below to teed to below to teed to be soldered to teed to be soldered to teed to be soldered to teed to below to teed to be soldered to teed to below to teed to soldered to teed to soldered to soldered to teed to soldered to s	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s²)  the to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table.  rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :  Inductance change: Within ±10%  No significant abnormality in appearance.  NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575 Type:  reflow oven at 230±5°C for 40 seconds, with peak temperature at 260±5°C for 5 seconds, 2 times.
Test Method and Remark NR30/40/50/60/80, NRV33 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV31 NRS40/50/60/80 Type NR10050 Type NR10050 Type NS12555, NS12565, NS125  Test Method and Remark The test samples shall Flux: Methanol soluti NR30/40/50/60/80, NRV31  Solder Temperature Time  **Immersion depth: All sides the sample shall	ss] 0, NRH24/30, 1 be soldered to be soldered to teed to below to teed to below to teed to be soldered to teed to be soldered to teed to be soldered to teed to below to teed to be soldered to teed to below to teed to soldered to teed to soldered to soldered to teed to soldered to s	or the test board by the reflow. est conditions.  y not exceed acceleration 196m/s³)  Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  Funder the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type:  Inductance change: Within ±10%  No significant abnormality in appearance.
Test Method and Remark NR30/40/50/60/80, NRV31 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV31 NRS40/50/60/80 Type NR10050 Type NR10050 Type NR1050 Type NS12555, NS12565, NS125  Test Method and Remark The test samples shall Flux: Methanol soluti NR30/40/50/60/80, NRV31  Solder Temperature Time  **Immersion depth: All si  15. Resistance to solderin NR30/40/50/60/80, NRV30 NRS40/50/60/80 Type NR10050 Type NR10050 Type NR10505, NS1255 Test Method and Remark NR30/40/50/60/80, NRV30 The test sample shall the test sampl	ss] 0, NRH24/30, 1 be soldered to be below to teed to be teed to be teed to be teed to teed t	of the test board by the reflow. est conditions.  y not exceed acceleration 196m/s³) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  flux, and then immersed in molten solder as shown in below table. rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :  Inductance change: Within ±10% No significant abnormality in appearance.  NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575 Type : reflow oven at 230±5°C for 40 seconds, with peak temperature at 280±5°C for 5 seconds, 2 times.  V50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NS12555, NS12575 Type)
Test Method and Remark NR30/40/50/60/80, NRV31 The test samples shall Then it shall be submit Frequency Range Total Amplitude Sweeping Method  Time  Recovery: At least 2h  14. Solderability NR30/40/50/60/80, NRV31 NRS40/50/60/80 Type NR10050 Type NS12555, NS12565, NS1255 [Test Method and Remark The test samples shall Flux: Methanol solution NR30/40/50/60/80, NRV31 Solder Temperature Time  **Immersion depth: All sides in the sides of the sides	ss] 0, NRH24/30, 1 be soldered to teled to below to teled to below to teled	othe test board by the reflow. est conditions.  y not exceed acceleration 196m/s*) Hz to 10Hz for 1min.  or 2 hours on each X, Y, and Z axis.  under the standard condition after the test, followed by the measurement within 48hrs.  At least 90% of surface of terminal electrode is covered by new solder.  At least 90% of surface of terminal electrode is covered by new solder.  Ifux, and then immersed in molten solder as shown in below table.  rosin 25%.  NRS40/50/60/80 Type, NS12555, NS12565, NS12575 Type :  Inductance change : Within ±10% No significant abnormality in appearance.  NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575 Type :  reflow oven at 230±5°C for 40 seconds, with peak temperature at 260±5°C for 5 seconds, 2 times.  1050/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NS12555, NS12555, NS12555, NS12555 Type)  10 Type)

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#### Wound Chip power inductor (NR, NS-series)

16. Thermal shock	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Inductance change: Within ±10%
NR10050 Type	No significant abnormality in appearance.
NS12555, NS12565, NS12575Type	

#### [Test Method and Remarks]

NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type:
The test samples shall be soldered to the test board by the reflow. The test samples shall be placed at specified temperature for specified time by step 1 to step 4 as shown in below table in sequence. The temperature cycle shall be repeated 100 cycles.

Conditions of 1 cycle		
Step	Temperature (°C)	Duration (min)
1	-40±3	30±3
2	Room temperature	Within 3
3	+85±2	30±3
4	Room temperature	Within 3

17. Damp heat	
NR30/40/50/60/80, NRV30, NRH24/30,	Inductance change: Within ±10%
NRS40/50/60/80 Type	No significant abnormality in appearance.
NR10050 Type	
NS12555, NS12565, NS12575Type	Inductance change: Within ±10%
No 12000, No 12000, No 12070 Type	No significant abnormality in appearance.

#### [Test Method and Remarks]

NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NS12555, NS12565, NS12575Type :

The test samples shall be soldered to the test board by the reflow.

The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.

Temperature	60±2℃
Humidity	90~95%RH
Time	500+24/-0 hour

18. Loading under damp heat	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Inductance change: Within ±10%
NR10050 Type	No significant abnormality in appearance.
NS12555, NS12565, NS12575Type	

#### [Test Method and Remarks]

NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type:

The test samples shall be soldered to the test board by the reflow.

The test samples shall be placed in thermostatic oven set at specified temperature and humidity and applied the rated current continuously as shown in below table.

Temperature	60±2℃
Humidity	90~95%RH
Applied current	Rated current
Time	500+24/-0 hour

19. Low temperature life test	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Inductance change: Within ±10%
NR10050 Type	No significant abnormality in appearance.
NS12555, NS12565, NS12575Type	

#### [Test Method and Remarks]

NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050 Type, NS12555, NS12565, NS12575Type:

The test samples shall be soldered to the test board by the reflow.

After that, the test samples shall be placed at test conditions as shown in below table.

Temperature	-40±2℃
Time	500+24/-0 hour

20. High temperature life test	
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	
	Inductance change: Within ±10% No significant abnormality in appearance.
NS12555, NS12565, NS12575Type	
Ten and a second of the	

# [Test Method and Remarks] NR10050 Type:

Temperature	105±3℃
Time	500+24/-0 hour

Recovery: At least 2hrs of recovery under the standard condition after the test, followed by the measurement within 48 hrs.

21. Loading at high temperature life test		
NR30/40/50/60/80, NRV30, NRH24/30,	Inductance change: Within ±10%	
NRS40/50/60/80 Type	No significant abnormality in appearance.	
NR10050 Type		
	Inductance change: Within ±10%  No significant abnormality in appearance.	

### [Test Method and Remarks]

NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NS12555, NS12565, NS12575Type: The test samples shall be soldered to the test board by the reflow soldering.

Temperature	85±2℃
Applied current	Rated current
Time	500+24/-0 hour

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### RELIABILITY DATA

#### Wound Chip power inductor(NR, NS-series)

would only power inductor (NT, No-series)		
22. Standard condition		
NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type	Standard test condition:  Unless otherwise specified, temperature is 20±15°C and 65±20% of relative humidity.  When there is any question concerning measurement result: In order to provide correlation data, the test shall be condition of 20±2°C	
NR10050 Type	of temperature, $65\pm5\%$ relative humidity.	
NS12555, NS12565, NS12575Type	Inductance is in accordance with our measured value.	

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### Wound Chip power inductor (NR, NS-series)

#### 1. Circuit Design

Operating environment

#### Precautions

1. The products described in this specification are intended for use in general electronic equipment, (office supply equipment, telecommunications systems measuring equipment, and household equipment). They are not intended for use in mission-critical equipment or systems requiring special quality and high reliability (traffic systems, safety equipment, aerospace systems, nuclear control systems and medical equipment including life-support systems,) where product failure might result in loss of life, injury or damage. For such uses, contact TAIYO YUDEN Sales Department in advance

#### 2. PCB Design

#### Precautions

◆Land pattern design

1. Please refer to a recommended land pattern.

#### Technical consider

- Land pattern design Surface Mounting
- ations
- Mounting and soldering conditions should be checked beforehand. Applicable soldering process to this products is reflow soldering only

#### 3. Considerations for automatic placement

#### ◆Adjustment of mounting machine

#### Precautions

- 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.
- 2. Mounting and soldering conditions should be checked beforehand.

#### Technical consider ations

Adjustment of mounting machine

1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

### 4. Soldering

#### ◆Reflow soldering

- 1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified.
- 2. The product shall be used reflow soldering only
- 3. Please do not add any stress to a product until it returns in normal temperature after reflow soldering.

#### ◆Lead free soldering

Precautions

# 1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, soldering etc sufficiently.

- ecommended conditions for using a soldering iron (NR10050 Type)

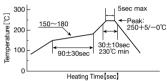
  - Put the soldering iron on the land-pattern.
    Soldering iron's temperature Below 350°C
  - Duration 3 seconds or less
  - · The soldering iron should not directly touch the inductor.

### ◆Reflow soldering

1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

•NR30/40/50/60/80, NRV30, NRH24/30, NRS40/50/60/80 Type, NR10050, NS12555, NS12565, NS12575 Type Recommended reflow condition (Pb free solder)

#### Technica considerations



#### 5. Cleaning

## Precautions

Cleaning conditions Washing by supersonic waves shall be avoided.

#### Technical considerations

1. if washed by supersonic waves, the products might be broken.

### 6. Handling

### ◆Handling

- 1. Keep the product away from all magnets and magnetic objects.
   ◆Breakaway PC boards (splitting along perforations)
- - 1. When splitting the PC board after mounting product, care should be taken not to give any stresses of deflection or twisting to the board.
- 2. Board separation should not be done manually, but by using the appropriate devices. Mechanical considerations

#### Precautions

- 1. Please do not give the product any excessive mechanical shocks
- 2. Please do not add any shock and power to a product in transportation.

#### ◆Pick-up pressure 1. Please do not push to add any pressure to a winding part. Please do not give any shock and push into a ferrite core exposure part.

◆Packing

1. Please avoid accumulation of a packing box as much as possible Breakaway PC boards (splitting along perforations)

#### The position of the product on PCBs shall be carefully considereed to minimize the stress caused from splitting of the PCBs. Mechanical considerations

#### Technical considerations

- There is a case to be damaged by a mechanical shock 2. There is a case to be broken by the handling in transportation

#### ◆Pick-up pressure

1. Damage and a characteristic can vary with an excessive shock or stress.

#### ◆Packing

1. If packing boxes are accumulated, that could cause a deformation on packing tapes or a damage on the products.

#### 7. Storage conditions

1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.

#### Precautions

· Recommended conditions Ambient temperature: -5~40℃ Humidity : Below 70% RH

The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, product should be used within 6 months from the time of delivery. In case of storage over 6 months, solderability shall be checked before actual usage

#### Technical considerations

### **♦**Storage

1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.

<sup>\*</sup> This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our Web site (http://www.ty-top.com/) or CD catalogs